mail

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

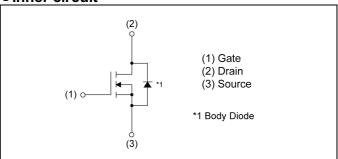




V _{DSS}	600V
R _{DS(on)} (Max.)	0.102Ω
Ι _D	±35A
P _D	379W



Inner circuit



Packaging specifications

	, , , , , , , , , , , , , , , , , , , ,	
	Packing	Tube
-	Reel size (mm)	-
	Tape width (mm)	-
Туре	Basic ordering unit (pcs)	450
	Taping code	C9
	Marking	R6035KNZ1

• Absolute maximum ratings (T_a = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit	
Drain - Source voltage	V _{DSS}	600	V	
Continuous drain current ($T_c = 2$	۱ _D *1	±35	А	
Pulsed drain current	I _{DP} *2	±105	А	
Gate - Source voltage	static	N/	±20	V
	AC(f>1Hz)	V _{GSS}	±30	V
Avalanche current, single pulse		I _{AS}	6.6	А
Avalanche energy, single pulse		E _{AS} *3	796	mJ
Power dissipation $(T_c = 25^{\circ}C)$		P _D	379	W
Junction temperature	Tj	150	°C	
Operating junction and storage te	T _{stg}	-55 to +150	S°	

Application

Switching

Features

1) Low on-resistance.

3) Parallel use is easy.

2) Ultra fast switching speed.

4) Pb-free lead plating ; RoHS compliant

•Thermal resistance

Deremeter	Cumph of	Values			Linit
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R_{thJC}^{*4}	-	-	0.33	°C/W
Thermal resistance, junction - ambient	R _{thJA}	-	-	30	°C/W
Soldering temperature, wavesoldering for 10s	T _{sold}	-	-	265	°C

•Electrical characteristics (T_a = 25°C)

Deremeter	Parameter Symbol Conditions		Values			Unit
Parameter			Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	$V_{(BR)DSS}$ $V_{GS} = 0V, I_D = 1mA$		600	-	-	V
		V _{DS} = 600V, V _{GS} = 0V				
Zero gate voltage drain current	I _{DSS}	$T_j = 25^{\circ}C$	-	-	100	μA
		$T_j = 125^{\circ}C$	-	-	1000	
Gate - Source leakage current	I _{GSS}	V_{GS} = ±20V, V_{DS} = 0V	-	-	±100	nA
Gate threshold voltage	V _{GS(th)}	V _{DS} = 10V, I _D = 1mA	3	-	5	V
		V _{GS} = 10V, I _D = 18.1A				
Static drain - source on - state resistance	$R_{DS(on)}^{*5}$	$T_j = 25^{\circ}C$	-	0.092	0.102	Ω
		$T_j = 125^{\circ}C$	-	0.200	-	
Gate resistance	R _G	f = 1MHz, open drain	-	1.0	-	Ω



• Electrical characteristics (T_a = 25°C)

Deremeter	Current of	Conditions	Values			Linit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Forward Transfer Admittance	Y _{fs} ^{*5} V _{DS} = 10V, I _D = 17.5A		11	22	-	S	
Input capacitance	C _{iss}	V _{GS} = 0V	-	3000	-		
Output capacitance	C _{oss}	V _{DS} = 25V	-	2300	-	pF	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	80	-		
Turn - on delay time	t _{d(on)} *5	$V_{DD} \simeq 300$ V, V_{GS} = 10V	-	45	-		
Rise time	t _r *5	I _D = 17.5A	-	150	-	20	
Turn - off delay time	t _{d(off)} *5	R _L ≃ 17.4Ω	-	90	-	ns	
Fall time	t _f *5	R _G = 10Ω	-	95	-		

• Gate charge characteristics ($T_a = 25^{\circ}C$)

Deremeter	Cump of	Conditions	Values			1.1
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Total gate charge	Q_g^{*5}	V _{DD} ≃ 300V	-	72	-	
Gate - Source charge	Q _{gs} *5	I _D = 35A	-	20	-	nC
Gate - Drain charge	Q _{gd} *5	V _{GS} = 10V	-	30	-	
Gate plateau voltage	V _(plateau)	$V_{DD} \simeq 300$ V, I _D = 35A	-	6.6	-	V

*1 Limited only by maximum channel temperature allowed.

*2 Pw \leq 10µs, Duty cycle \leq 1%

*3 L \doteqdot 500µH, V_{DD}=50V, R_G=25 Ω , STARTING T_j=25°C

*4 T_C=25°C

*5 Pulsed

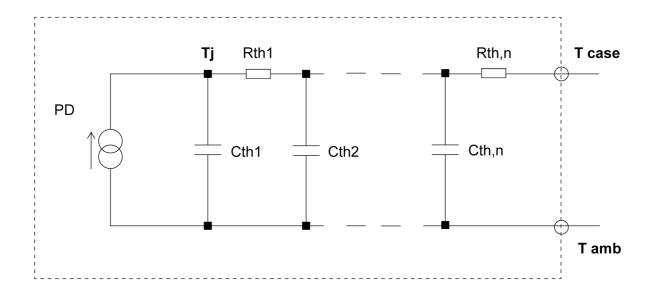


•Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Parameter	Sympol	Conditions	Values			Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Continuous forward current	۱ _S *1	T - 25°0	-	-	35	А	
Pulse forward current	ا _{SP} *2	T _C = 25°C	-	-	105	А	
Forward voltage	V_{SD}^{*5}	V _{GS} = 0V, I _S = 35A	-	-	1.5	V	
Reverse recovery time	t _{rr} *5		-	605	-	ns	
Reverse recovery charge	Q _{rr} *5	I _S = 35A di/dt = 100A/µs	-	14.5	-	μC	
Peak reverse recovery current	۲ _{rrm} *5		-	45	-	А	

• Typical transient thermal characteristics

Symbol	Value	Unit	Symbol	Value	Unit
R _{th1}	0.151		C _{th1}	0.018	
R _{th2}	0.428	K/W	C _{th2}	0.400	Ws/K
R _{th3}	0.250		C _{th3}	15.4	





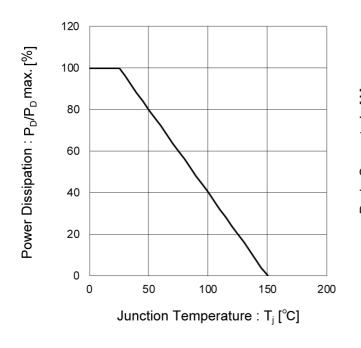


Fig.1 Power Dissipation Derating Curve

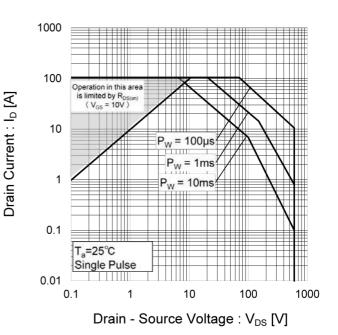
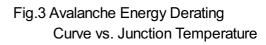
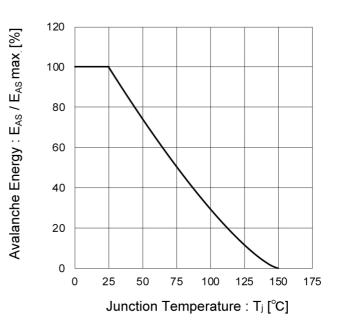


Fig.2 Maximum Safe Operating Area







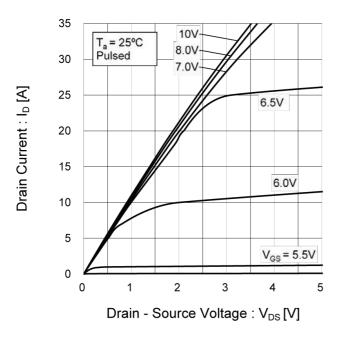
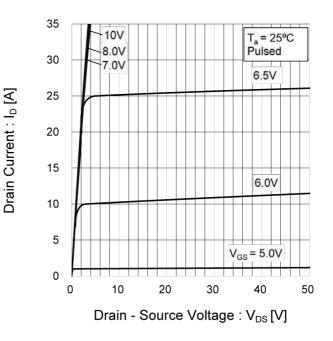


Fig.4 Typical Output Characteristics(I)

Fig.5 Typical Output Characteristics(II)





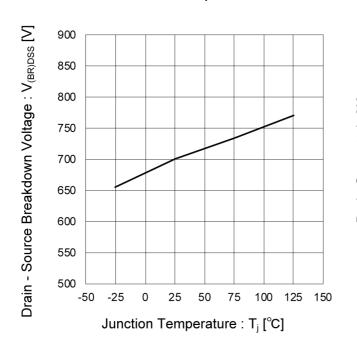


Fig.6 Breakdown Voltage vs. Junction Temperature

Fig.7 Typical Transfer Characteristics

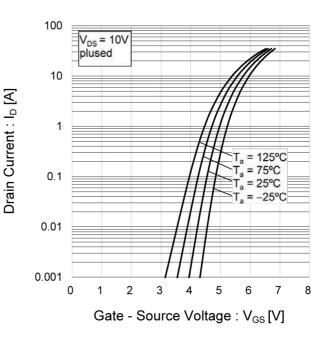


Fig.8 Gate Threshold Voltage vs. Junction Temperature



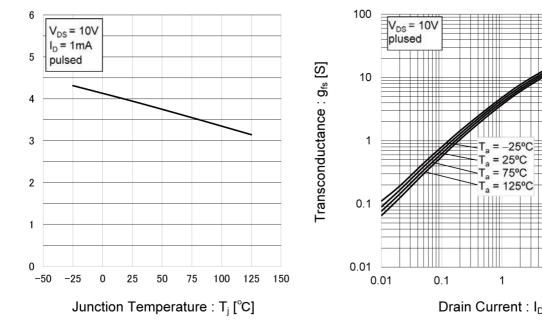
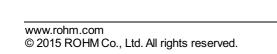


Fig.9 Forward Transfer Admittance vs. Drain Current





100

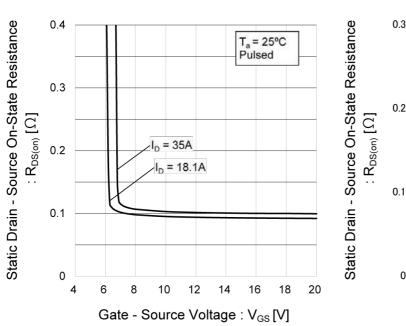
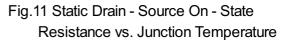


Fig.10 Static Drain - Source On - State Resistance vs. Gate Source Voltage



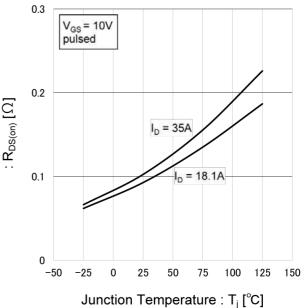
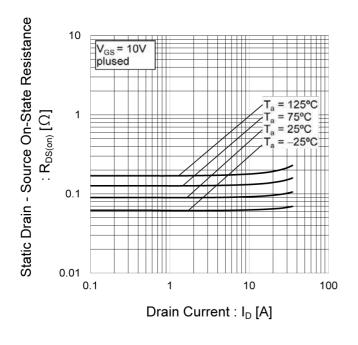


Fig.12 Static Drain - Source On - State Resistance vs. Drain Current(I)



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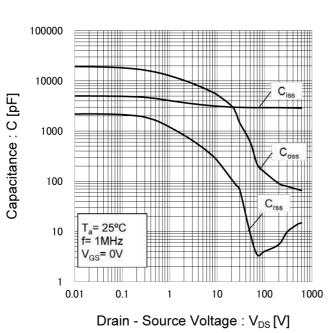
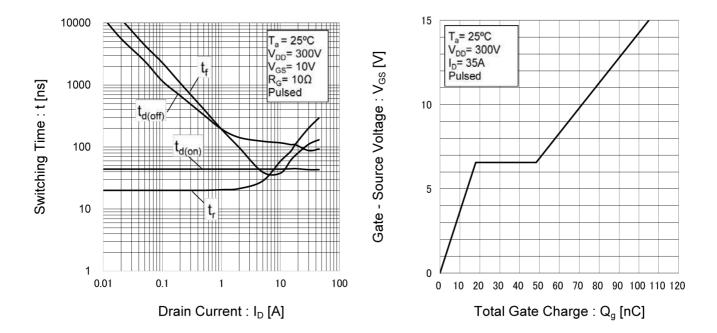


Fig.13 Typical Capacitance vs. Drain - Source Voltage

Fig.14 Switching Characteristics

Fig.15 Dynamic Input Characteristics





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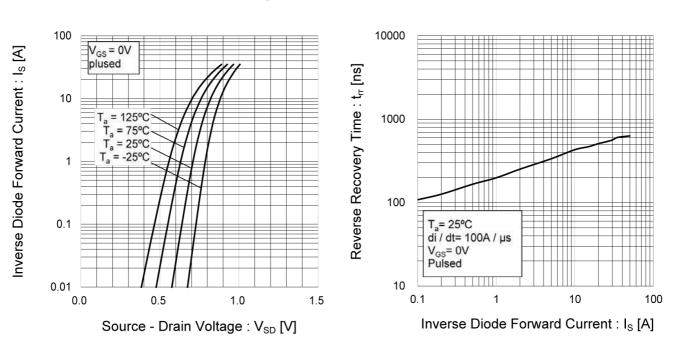


Fig.16 Inverse Diode Forward Current vs. Source - Drain Voltage





Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

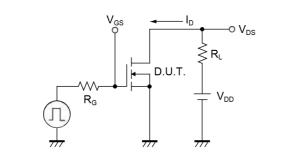


Fig.2-1 Gate Charge Measurement Circuit

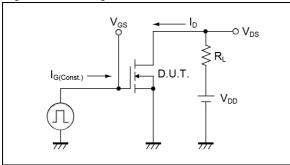


Fig.3-1 Avalanche Measurement Circuit

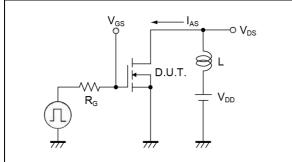


Fig.4-1 dv/dt Measurement Circuit

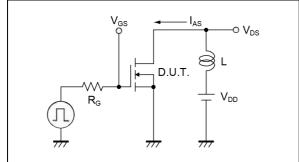


Fig.5-1 dv/dt Measurement Circuit

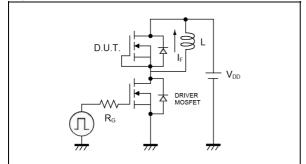


Fig.1-2 Switching Waveforms

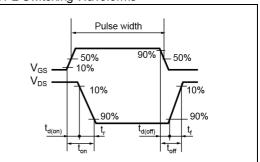


Fig.2-2 Gate Charge Waveform

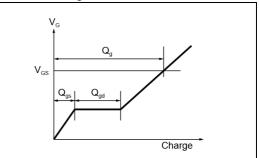


Fig.3-2 Avalanche Waveform

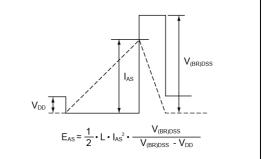


Fig.4-2 dv/dt Waveform

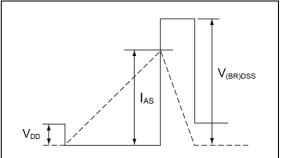
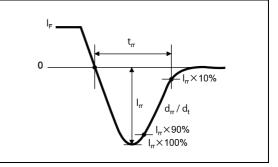
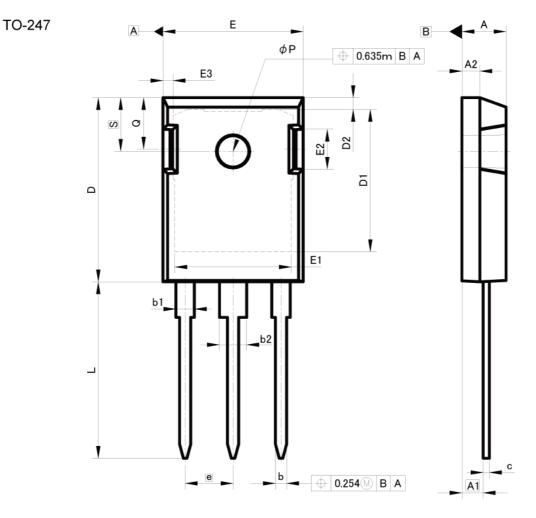


Fig.5-2 dv/dt Waveform





Dimensions



DIM	MILIM	ETERS	INC	HES	
DIW	MIN	MAX	MIN	MAX	
А	4.83	5.21	0.19	0.205	
A1	2.29	2.54	0.09	0.1	
A2	1.91	2.16	0.075	0.085	
b	1.14	1.40	0.045	0.055	
b1	1.91	2.20	0.075	0.087	
b2	2.92	3.20	0.115	0.126	
С	0.61	0.80	0.024	0.031	
D	20.80	21.34	0.819	0.84	
D1	17.43	17.83	0.686	0.702	
Е	15.75	16.13	0.62	0.635	
е	5.45		0.	22	
Ν	3			3	
L	19.81	20.57	0.78	0.81	
L1	3.81	4.07	0.15	0.16	
ΦP	3.55	3.65	0.14	0.144	
Q	5.59	6.20	0.22	0.244	
S	6.	15	0.	24	

Dimension in mm/inches



Notice

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1. Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment ^(Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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R6035KNZ1 - Web Page

Distribution Inventory

Part Number	R6035KNZ1
Package	TO-247
Unit Quantity	450
Minimum Package Quantity	450
Packing Type	Bulk
Constitution Materials List	inquiry
RoHS	Yes